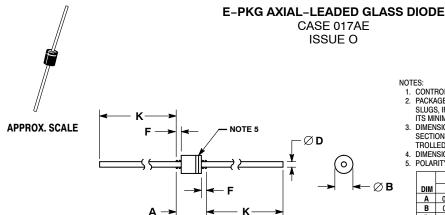
## **MECHANICAL CASE OUTLINE**

PACKAGE DIMENSIONS





**DATE 10 AUG 2012** 

## NOTES:

- VOIES:

  1. CONTROLLING DIMENSION: INCHES

  2. PACKAGE CONTOUR IS OPTIONAL WITHIN DIMENSIONS A AND B. HEAT SLUGS, IF ANY, SHALL BE WITHIN DIMENSION B BUT NOT SUBJECT TO ITS MINIMUM VALUE.
- ITS MINIMUM VALUE.

  3. DIMENSION A DEFINES THE ENTIRE BODY INCLUDING HEAT SLUGS AND SECTIONS OF THE LEAD OVER WHICH THE DIAMETER IS UNCONTROLLED. DIMENSION F DEFINES THESE SECTIONS OF THE LEAD.

  4. DIMENSION B IS MEASURED AT THE MAXIMUM DIAMETER OF THE BODY.

  5. POLARITY SHALL BE DENOTED BY A CATHODE BAND.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.130	0.300	3.30	7.62
В	0.115	0.142	2.92	3.61
D	0.036	0.042	0.91	1.07
F		0.050		1.27
K	0.900	1.300	22.86	33.02

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DESCRIPTION:	E-PKG AXIAL-LEADED GLASS DIODE		PAGE 1 OF 1

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